AVAGO TECHNOLOGIES, LTD. 4380 Ziegler Road, MS: 76 Fort Collins, Colorado 80525

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor(s): R. Shane Fazio

Serial No.: 10/807,417 Examiner: Monica Lewis

Filing Date: March 23, 2004 Group Art Unit: 3854

Title: Microcap Wafer Bonding Apparatus

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria VA 22313-1450

NOTICE OF APPEAL FROM THE EXAMINER TO THE BOARD OF PATENT APPEALS AND INTERFERENCES

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Applicant hereby appeals to the Board of Patent Appeals and Interferences from the decision of the examiner dated, July 18, 2008 , rejecting the following claims 24-27 and 31-36

The fee for this Notice of Appeal (37 CFR 1.17(b)) is \$510.00.

(complete (a) or (b) as applicable)

The proceedings herein are for a patent application and the provisions of 37 CFR 1.136(a) apply.

	months checked be		
L	one month	\$ 120.00	
	two months	\$ 460.00	
	three months	\$1050.00	
	four months	\$1640.00	

(b) Applicant believes that no extension of term is required. However, this conditional petition is being made to provide for the possibility that applicant has inadvertently overlooked the need for a petition and fee for extension of time.

Please charge to Deposit Account 503718 the sum of \$510.00 . At any time during the pendency of this application, please charge any fees required or credit any overpayment to Deposit Account 503718 pursuant to 37 CFR 1.25.

Ву

A duplicate copy of this transmittal letter is enclosed.

Respectfully submitted,

R. Shane Fazio

Thomas F. Woods

Attorney/Agent for Applicant(s)

Reg. No. 36,726

Date: October 20, 2008

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